



Parameter	Rating	Units
Breakdown Voltage - $BV_{CEO}$	30	$V_P$
Current Transfer Ratio - CTR (typical)	8500	%
Saturation Voltage - $V_{CE(sat)}$	1	V
Input Control Current - $I_F$	1	mA

### Features

- Uni-directional Input
- Small 8-Pin Package, Thru-Hole or Surface Mount
- 100mA Continuous Load Rating
- 3750V<sub>rms</sub> Input/Output Isolation
- Machine Insertable, Wave Solderable
- Surface Mount Tape & Reel Packaging Available

### Applications

- Telecom Switching
- Tip/Ring Circuits
- Modem Switching (Laptop, Notebook, Pocket Size)
- Loop Detect
- Ringing Detect
- Current Sensing

### Description

LDA213 is a dual uni-directional input optocoupler with a darlington transistor output. The LDA213 has a minimum current transfer ratio (CTR) of 300% with a typical value of 8500%.

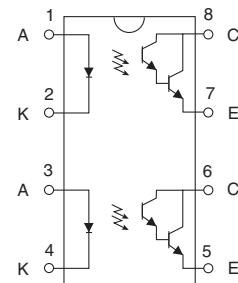
### Approvals

- UL Recognized Component: File # E76270
- CSA Certified Component: Certificate # 1175739

### Ordering Information

Part Number	Description
LDA213	8-Pin DIP (50/tube)
LDA213S	8-Pin Surface Mount (50/tube)
LDA213STR	8-Pin Surface Mount (1000/Reel)

### Pin Configuration



### Absolute Maximum Ratings

Parameter	Ratings	Units
Breakdown Voltage	30	V <sub>P</sub>
Reverse Input Voltage	5	V
Input Control Current	100	mA
Peak (10ms)	1	A
Power Dissipation		
Input Power Dissipation <sup>1</sup>	150	mW
Phototransistor <sup>2</sup>	150	
Isolation Voltage, Input to Output	3750	V <sub>rms</sub>
Operational Temperature	-40 to +85	°C
Storage Temperature	-40 to +125	°C

<sup>1</sup> Derate Linearly 1.33 mW/°C

<sup>2</sup> Derate Linearly 2.0 mW/°C

Electrical absolute maximum ratings are at 25°C

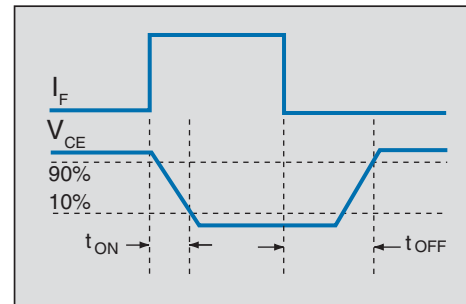
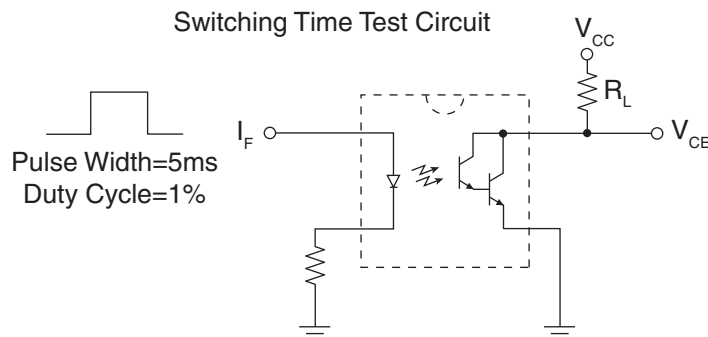
Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

### Electrical Characteristics

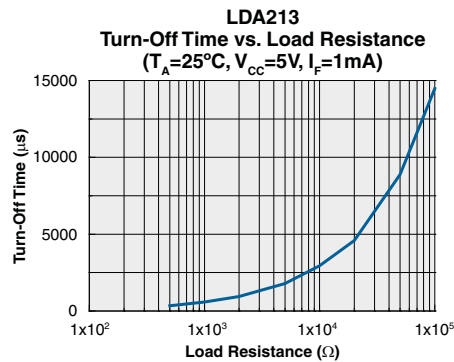
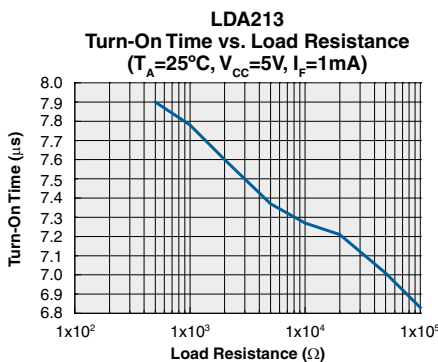
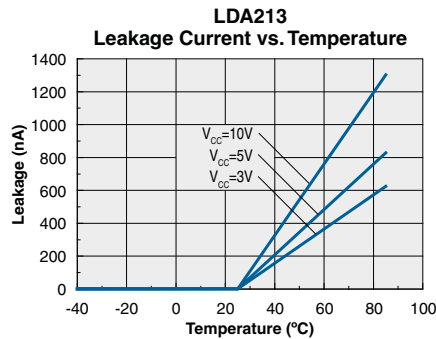
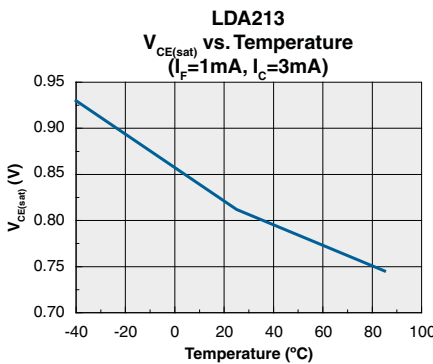
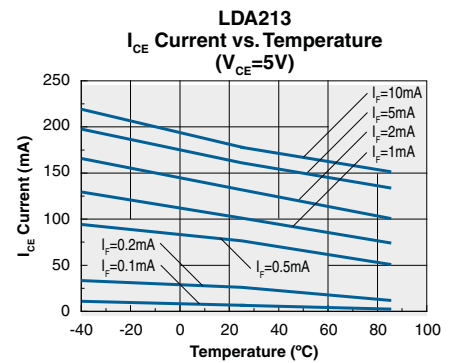
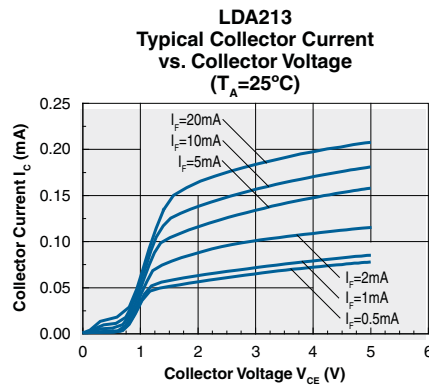
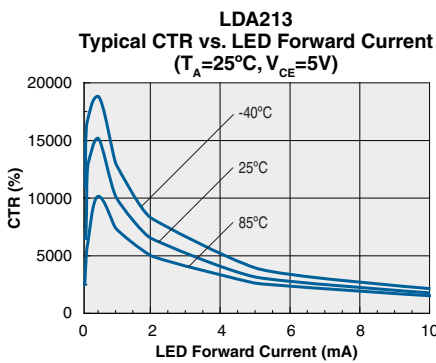
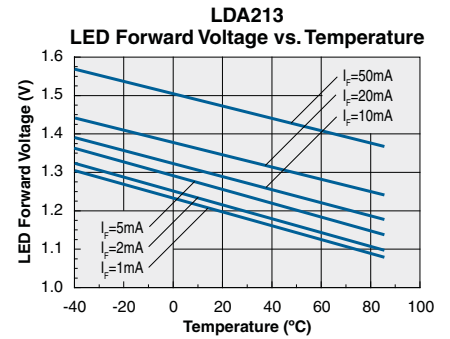
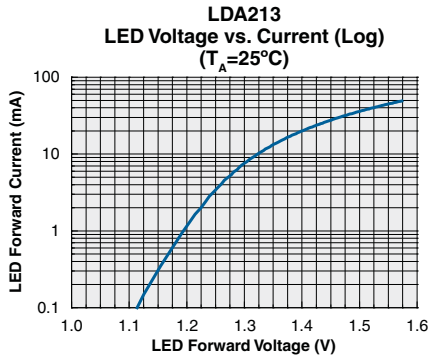
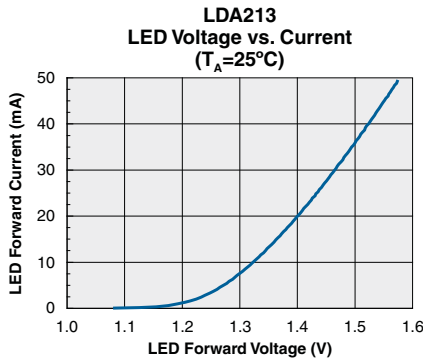
Parameter	Conditions	Symbol	Min	Typ	Max	Units
<b>Output Characteristics @ 25°C</b>						
Phototransistor Breakdown Voltage	I <sub>C</sub> = 100µA	BV <sub>CEO</sub>	30	50	-	V
Phototransistor Dark Current	V <sub>CEO</sub> = 5V, I <sub>F</sub> = 0mA	I <sub>CEO</sub>	-	50	500	nA
Saturation Voltage	I <sub>C</sub> = 3mA, I <sub>F</sub> = 1mA	V <sub>CE(sat)</sub>	-	-	1	V
Current Transfer Ratio	I <sub>F</sub> = 1mA, V <sub>CE</sub> = 2V	CTR	300	8500	30000	%
Output Capacitance	50V, f = 1MHz	C <sub>OUT</sub>	-	3	-	pF
<b>Input Characteristics @ 25°C</b>						
Input Control Current	I <sub>C</sub> = 3mA, V <sub>CE</sub> = 2V	I <sub>F</sub>	-	0.07	1	mA
Input Voltage Drop	I <sub>F</sub> = 5mA	V <sub>F</sub>	0.9	1.2	1.4	V
Reverse Input Current	V <sub>R</sub> = 5V	I <sub>R</sub>	-	-	10	µA
<b>Common Characteristics @ 25°C</b>						
Capacitance, Input to Output	-	C <sub>I/O</sub>	-	3	-	pF

### Switching Characteristics @ 25°C

Characteristic	Symbol	Test Condition	Typ	Units
Turn-On Time	t <sub>ON</sub>	V <sub>CC</sub> =5V, I <sub>F</sub> =1mA, R <sub>L</sub> =500Ω	8	µs
Turn-Off Time	t <sub>OFF</sub>		345	



**PERFORMANCE DATA\***



\*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

**Manufacturing Information**

**Soldering**

For proper assembly, the component must be processed in accordance with the current revision of IPC/JEDEC standard J-STD-020. Failure to follow the recommended guidelines may cause permanent damage to the device resulting in impaired performance and/or a reduced lifetime expectancy.

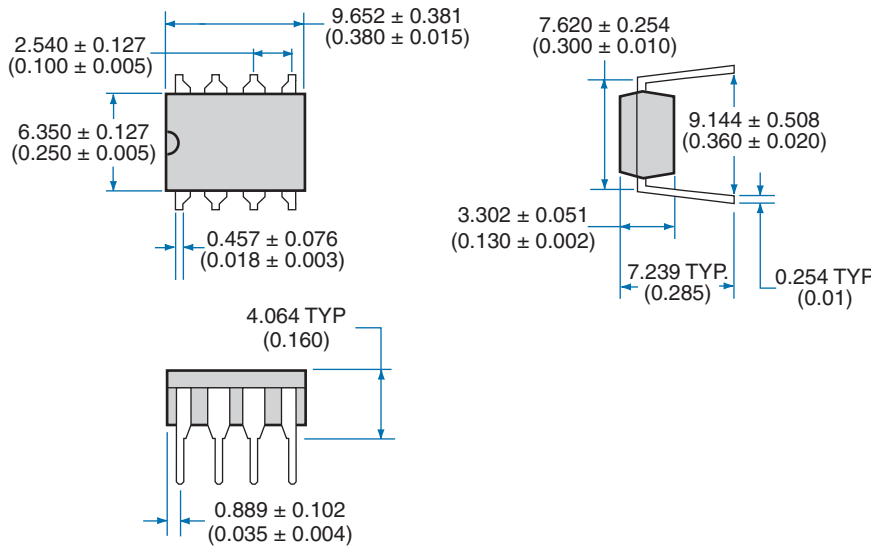
**Washing**

Clare does not recommend ultrasonic cleaning or the use of chlorinated solvents.

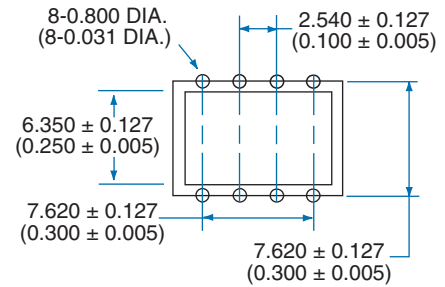


**MECHANICAL DIMENSIONS**

**8-Pin DIP Through-Hole Package**

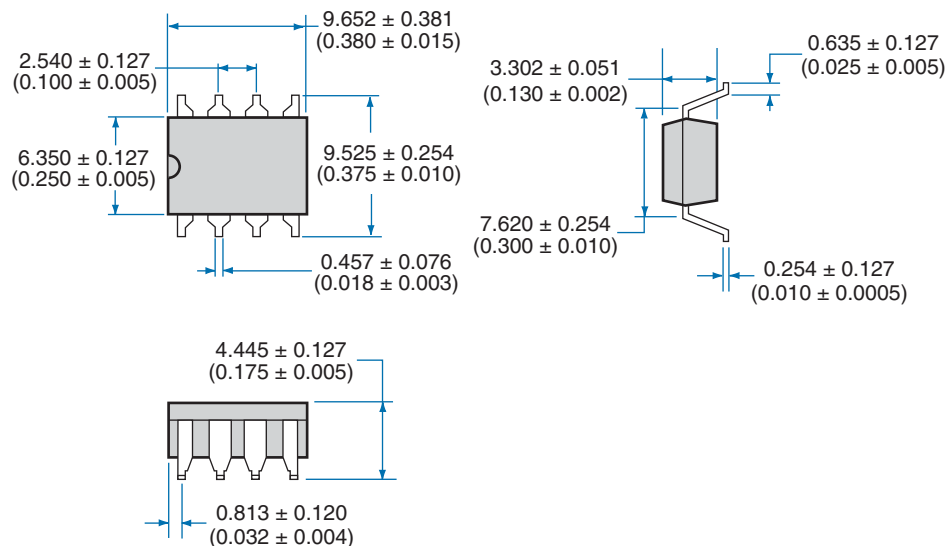


**PC Board Pattern**

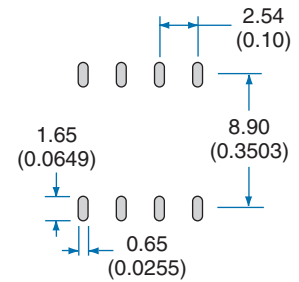


Dimensions  
mm  
(inches)

**8-Pin Surface Mount Package**



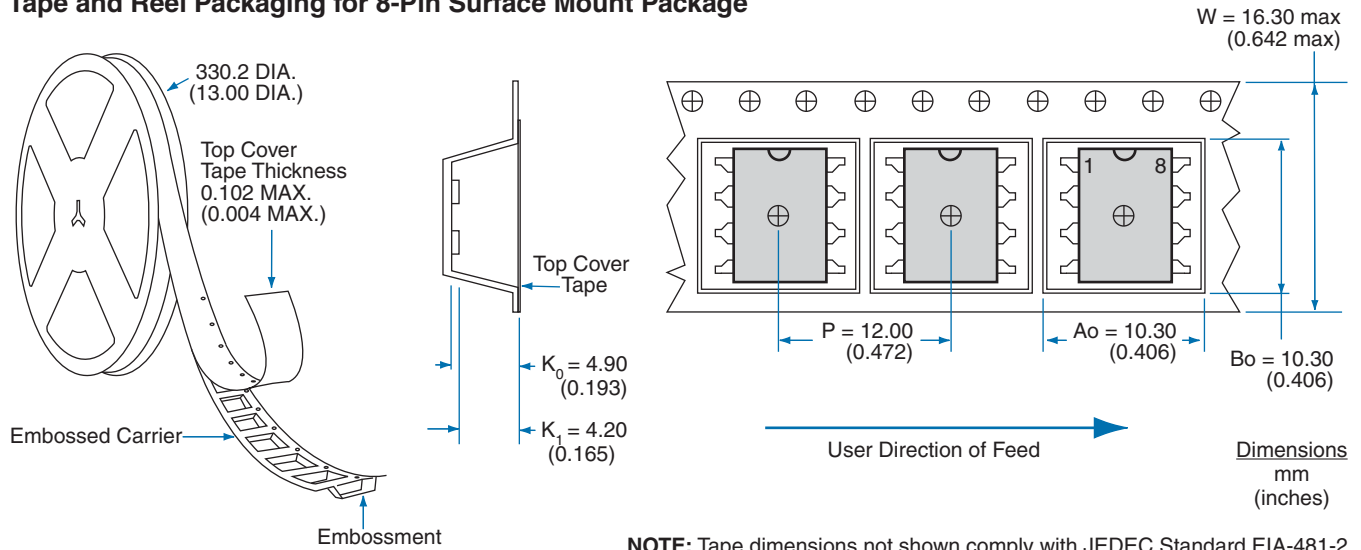
**Recommended PCB Land Pattern**



Dimensions  
mm  
(inches)

**MECHANICAL DIMENSIONS**

**Tape and Reel Packaging for 8-Pin Surface Mount Package**



**NOTE:** Tape dimensions not shown comply with JEDEC Standard EIA-481-2

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